

FCL Components Wireless Modules

Bluetooth® Version 4.2 (low energy)

(Firmware Embedded & Central/Peripheral)

FWM7BLZ20

Overview

Compact *Bluetooth* Low energy module with high performance processor, half the power consumption than its predecessor and double the transmission distance.



Features

- Bluetooth specification Version 4.2 (LE single mode) compliant
- Based on Nordic Semiconductor nRF52832 (ARM Cortex-M4F, 512KB flash, and 64KB RAM embedded)
- Complete Bluetooth protocol stack provided by Nordic Semiconductor
- External interface: 30 GPIO pins for SPI, TWI, UART, and ADC
- Capable to communicate with up to 8 peripherals simultaneously through the “GATT Direct Access Function”. This function allows communication with other manufacturers’ Bluetooth modules.



FWM7BLZ20

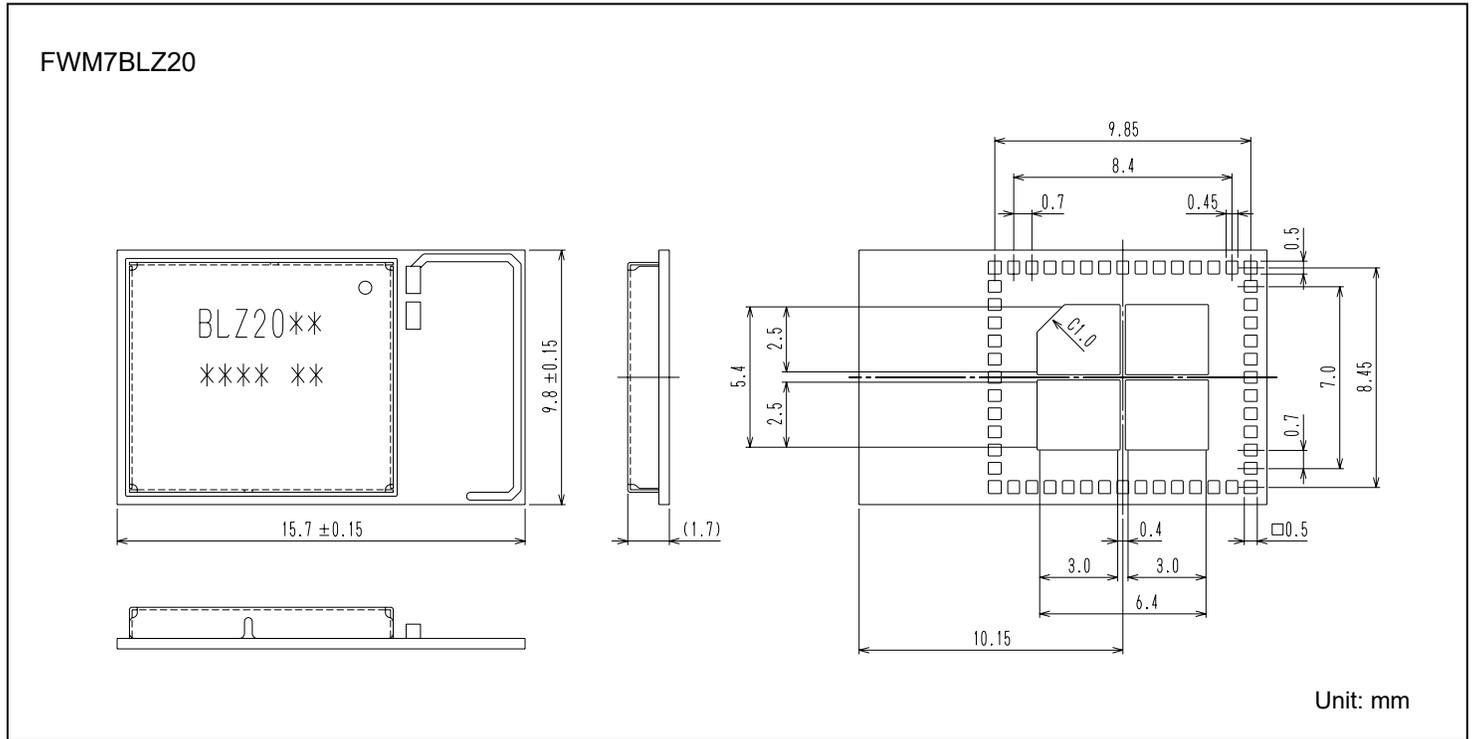
| Item | Specifications |
|-----------------------|--|
| Part number | FWM7BLZ20 |
| Antenna | Pattern antenna |
| Bluetooth technology | Conforms to <i>Bluetooth</i> Core Specification Version 4.2 (single mode low energy radio) |
| RAM | 64KB |
| Transmit power | +4 dBm max. |
| Receiver sensitivity | -94 dBm typical |
| Interface | UART, SPI, GPIO, SWDCLK, SWIDO, nRESET, TWI, ADC |
| Crystal oscillator | Embedded |
| Operating temperature | -40°C to +85°C |
| Operating voltage | 1.7 ~ 3.6VDC |
| Power consumption | Tx mode LDO mode: 11.6 mA typical (at 0dBm), DC/DC mode: 5.3mA typical (at 0dBm) |
| | Rx mode LDO mode: 11.7 mA typical DC/DC mode: 5.4mA typical |
| Number of GPIO | 30 |
| Dimensions | 15.7 x 9.3 x 1.7 mm |
| Mounting method | Surface mount (SMD) |
| Certifications | Bluetooth qualification (QDID) / Radio Act (Japan) / FCC / IC / CE |

Evaluation kit

| Part number | Details |
|--|----------------------------------|
| FWM7BLZ20-EF2-KIT-2 | Evaluation kit |
| Contains: | |
| - MBH-FUJI2-E1 (USB cable is included) | Evaluation board |
| - FWM7BLZ20-DAU2-EF2 | Module mounted on daughter board |

Note: *Bluetooth* SIG registration is required to use this module's QDID.

■ Dimensions



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